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## BIB DATA SHEET

CONFIRMATION NO. 3494

SERIAL NUMBER	FILING or 371(c) DATE	CLASS	GROUP ART UNIT	ATTORNEY DOCKET NO.		
10/802,563	03/17/2004 RULE	257	2823	NUS03-001		
<b>APPLICANTS</b> Hong Yu Yu, Singapore, SINGAPORE; Ming-Fu Li, Singapore, SINGAPORE; Dim-Lee Kwong, Austin, TX; Lakshmi Kanta Bera, Singapore, SINGAPORE;						
<b>** CONTINUING DATA *****</b> <b>** FOREIGN APPLICATIONS *****</b> <b>** IF REQUIRED, FOREIGN FILING LICENSE GRANTED **</b> 06/01/2004						
Foreign Priority claimed <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No 35 USC 119(a-d) conditions met <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No Verified and /SU C KIM/ Acknowledged <u>Examiner's signature</u>		<input type="checkbox"/> Met after Allowance <u>Initials</u>	<b>STATE OR COUNTRY</b> SINGAPORE	<b>SHEETS DRAWINGS</b> 4	<b>TOTAL CLAIMS</b> 34	<b>INDEPENDENT CLAIMS</b> 4
<b>ADDRESS</b> SAILE ACKERMAN LLC 28 DAVIS AVENUE POUGHKEEPSIE, NY 12603 UNITED STATES						
<b>TITLE</b> Thermal robust semiconductor device using HfN as metal gate electrode and the manufacturing process thereof						
<b>FILING FEE RECEIVED</b> 1308	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit			